

Electrical Resistance as a NDE Technique to Monitor Processing and Damage Accumulation in SiC/SiC Composites

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Ceramic matrix composites are suitable for high temperature structural applications such as turbine airfoils and hypersonic thermal protection systems. The employment of these materials in such applications is limited by the ability to process components reliable and to accurately monitor and predict damage evolution that leads to failure under stressed-oxidation conditions. Current nondestructive methods such as ultrasound, x-ray, and thermal imaging are limited in their ability to quantify small scale, transverse, in-plane, matrix cracks developed over long-time creep and fatigue conditions. Electrical resistance of SiC/SiC composites is one technique that shows special promise towards this end. Since both the matrix and the fibers are conductive, changes in matrix or fiber properties should relate to changes in electrical conductivity along the length of a specimen or part. Initial efforts to quantify the electrical resistance of different fiber and different matrix SiC/SiC composites will be presented. Also, the effect of matrix cracking on electrical resistance as a technique applied to composite processing, damage detection, and lifemodeling will be discussed.



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Outline

- Objective
- Literature
- What effects electrical conductivity
- Experimental
- Application I: Composite Characterization
- Application II: Damage Characterization
- Electro/Mechanical Modeling
- Summary and Conclusions



Objective

- To determine if and to what extent electrical resistance can be used as a self-sensing nondestructive evaluation technique for SiC-based fiberreinforced composites
 - Composite characterization
 - Damage accumulation
 - Analysis technique
 - Monitoring as an inspection or possibly on-board device
 - Electro/Mechanical Modeling → Performance and Lifemodeling



Some studies in the literature

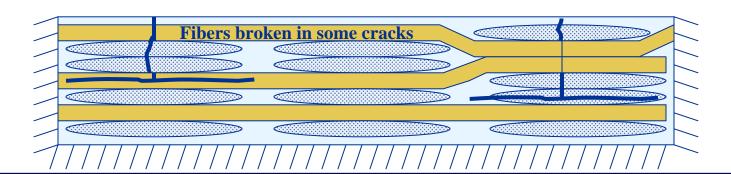
(mostly w/C fibers in epoxy, glass, or CVI SiC)

- Many papers last 20 years on C fiber reinforced polymer, concrete and carbon matrix composites
 - Strain and damage monitoring
- Frankhanel et al., J. Euro. Ceram. (2001) SiC-Fibre reinforced glasses – electrical properties and their application
- H. Mei and L Cheng., Mater. Let. (2005) Damage analysis of 2D C/SiC composites subjected to thermal cycling in oxidizing environments by mechanical and electrical characterization



What effects electrical resistivity? $\rho = \text{Resistance} \bullet (\text{Area/Length})$

- The content and structure of composite
 - Constituents (fiber, interphase and matrix) and their relative resistivities
 - Nature and amount of porosity
 - Fiber architecture
- Stress
- The damage state
 - Already present (e.g., C/SiC) or as a result of stressed-oxidation (SiC/SiC)?
 - Transverse and/or interlaminar cracking?
- The oxidation and/or recession state
- Lead attachment on the face, on an edge, an extension from within the structure?



Current Source

Gage

Section

Current Source

Voltage Measurement

Voltage Measurement



Experimental



 Resistance measured by four- point probe method using an Agilent 34420 micro-Ohm meter

 Conductive silver paste was used to improve contact between specimen and voltmeter

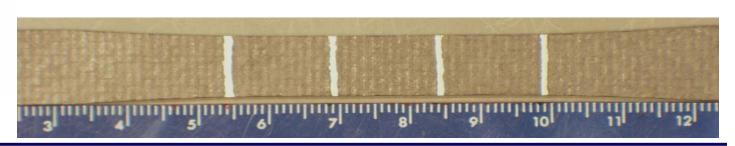
For mechanical tests:

 Loaded, unloaded, and reloaded in tension on an Instron Universal Testing Machine (4kN/min)

 Capacitance strain gage used with 1% range over 25mm (metal knife-edge contact extensometers were tried, but abandoned because of electrical interference)

Resistance measurement made every second

 Acoustic emission monitored by 50kHz to 2MHz sensors just outside the gage section







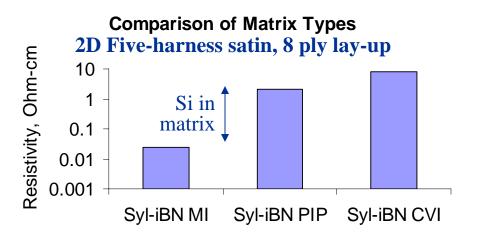
Application I: Composite Characterization

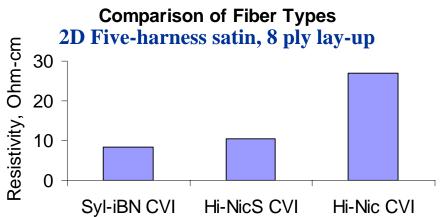
The relative resistivities of the constituents, porosity, and fiberarchitecture all play a role in the overall resistivity of the composite... which should show consistent differences when varied.

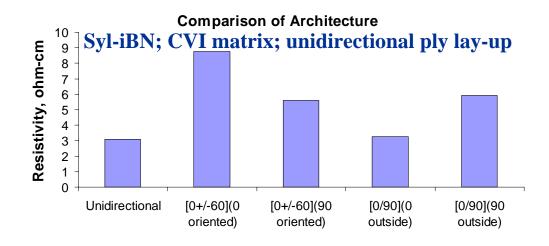
- We varied fiber-types, matrix-types, and fiber architectures...
 - Matrix Variation: 5 harness satin, 8 ply, Sylramic-iBN, BN interphase with
 - Melt-infiltrated (CVI + SiC particles + Si) matrix NASA N24A COMPOSITE
 - CVI SiC only
 - PIP matrix (S300 Variation)
 - Fiber type, with a CVI SiC matrix...
 - Sylramic-iBN,
 - Hi-Nicalon Type S
 - Hi-Nicalon
 - Architecture, with a CVI SiC matrix...
 - Unidirectional lay-up,
 - 0/90 lay-up
 - 0/<u>+</u>60 lay-up



Application I: Composite Characterization









Application I: Composite Characterization (Extension to Quality Control)

 In principle, this should be applicable to monitoring processing of SiC/SiC composites. For example, if processing parameters can be related to resistivity (conductivity), this could be used as a quality control technique.



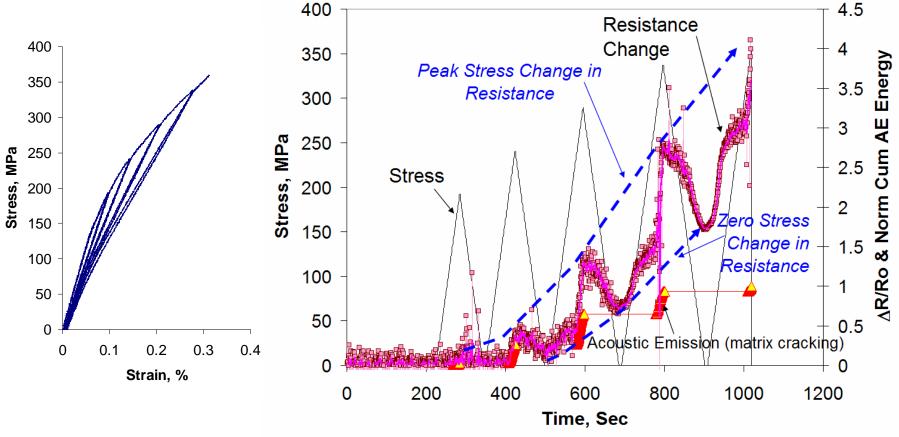
Application II: Damage Characterization

Sylramic-iBN/MI 2D Woven Composite (f=0.4)

As damage progresses, the circuit changes for electrical conductivity, increasing the resistivity of the composite.

The change is on the order of several hundred percent... this

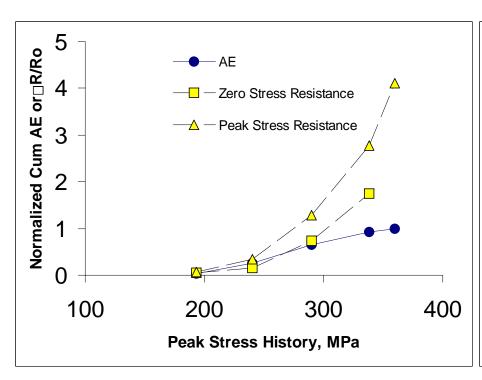
is a huge sensitivity factor!

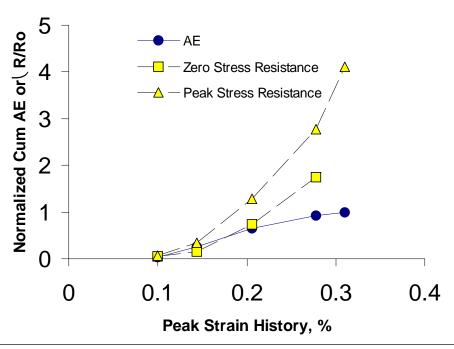




Application II: Damage Characterization Sylramic-iBN/MI 2D Woven Composite (f=0.4)

- Resistance at zero-stress (inspection application) very similar to AE, i.e., matrix crack density for lower stress/strain conditions
- Peak stress/strain resistance changes significantly with stress/strain → potential for in-situ monitoring and recognition of transient stress events



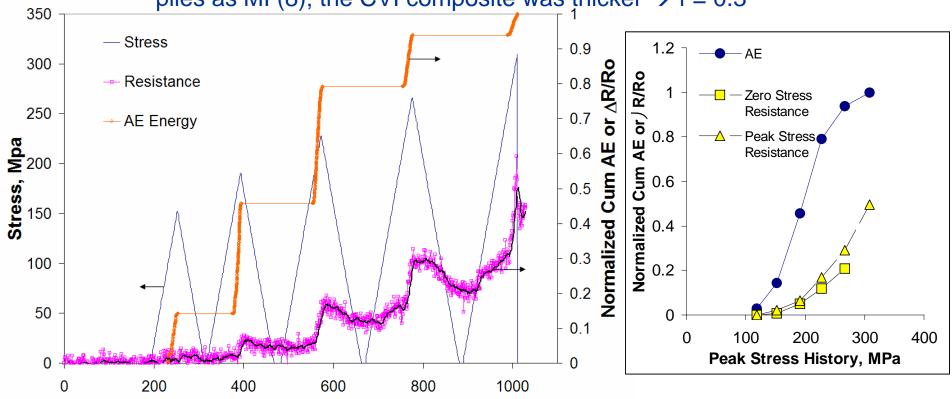




Application II: Damage Characterization Syl-iBN/CVI Matrix Woven Composite (f = 0.3)

 CVI matrix composite shows similar trends as MI; however the relative change in resistance with stress is about an order of magnitude less than for MI, but still an order of magnitude higher than C fiber reinforced systems

It should be noted, though the composite had the same number of plies as MI (8); the CVI composite was thicker → f = 0.3



Time, sec

Application II: Damage Characterization (Extension to Time-Temperature-Stress Conditions)

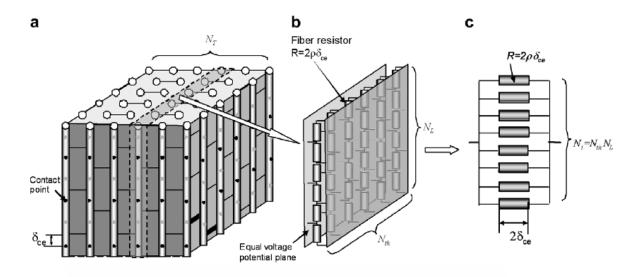
 In principle, as unbridged cracks form and oxidizing species fill matrix cracks and/or pores and/or oxidation reactions cause recession of composite, resistance changes should occur. If they can be quantified, then this technique offers a way of health monitoring.

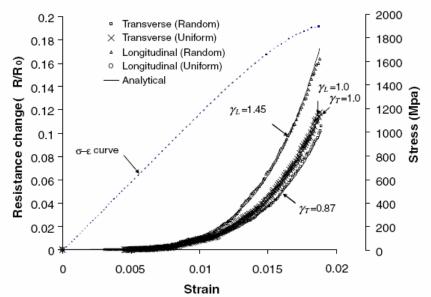


Electro/Mechanical Modeling

- e.g., Z.H. Xia and W.A. Curtin, "Modeling of mechanical damage detection in CFRPs via electrical resistance", Comp. Sci. Tech., 2007
- Fibers as resistors
- "electrical ineffective length" defined by broken fibers

Next step is to model electro/mechanical performance considering conductivities of constituents and fiber architectures







Summary and Conclusions

- Electrical resistance in SiC-based CMCs is very sensitive to constituent content, fiber-architecture, and stress/strain history
- Electrical resistance offers a useful way to characterize SiC-based CMCs, both as-produced and after mechanical damage
- This technique offers potential as a method of quality control for processing these composites and as a means to monitor the health of SiC-based CMC components in-situ or as an inspection technique



Future Work

- Compare different composites varying composite constituents and fiber architecture
- Determine usefulness of this technique during elevated temperature testing, e.g., stress-rupture in air
- Determine lead attachment schemes for different applications and conditions
- Develop an electro/mechanical model for different composite systems relating electrical and mechanical performance with an aim toward life-modeling

See Craig's poster at A Cer S Reception tonight!